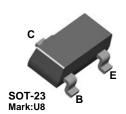


September 2012

BSR14 NPN General Purpose Amplifier

Features

- This device is for use as a medium power amplifier and switch requiring collector currents up to 500 mA.
- Sourced from Process 19.
- · See BCW65C for characteristics.



Absolute Maximum Ratings* T_a = 25°C unless otherwise noted

Symbol	Parameter	Value	Units	
V _{CEO}	Collector-Emitter Voltage	40	V	
V _{CBO}	Collector-Base Voltage	75	V	
V _{EBO}	Emitter-Base Voltage	6.0	V	
I _C	Collector Current - Continuous	800	mA	
T _{J,} T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C	

^{*} These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics $T_a = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Max.	Units	
		*BSR14		
P _D	Total Device Dissipation	350	mW	
	Derate above 25°C	2.8	mW/°C	
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient	357	°C/W	

^{*} Device mounted on FR-4 PCB 40 mm X 40 mm X 1.5 mm.

¹⁾ These ratings are based on a maximum junction temperature of 150 degrees C.

²⁾ These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle

Electrical Characteristics $T_a = 25$ °C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
OFF CHARAC	TERISTICS				1
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage	$I_C = 10 \mu A, I_B = 0$	40		V
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_C = 10\mu A, I_E = 0$	75		V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_E = 10\mu A, I_C = 0$	6.0		V
I _{CBO}	Collector-Cutoff Current	V _{CB} = 60V, V _{CB} = 60V, T _a = 150°C		10 10	nA μA
I _{CEX}	Collector-Cutoff Current	$V_{CE} = 60V, V_{EB} = 3.0V$		10	nA
I _{BEX}	Reverse Base Current	$V_{CE} = 60V, V_{EB} = 3.0V$		20	nA
I _{EBO}	Emitter-Cutoff Current	$V_{EB} = 3.0V, I_{C} = 0$		15	nA
ON CHARACT	TERISTICS				ļ.
h _{FE}	DC Current Gain	$\begin{split} & I_{C} = 0.1 \text{mA}, V_{CE} = 10 \text{V} \\ & I_{C} = 1.0 \text{mA}, V_{CE} = 10 \text{V} \\ & I_{C} = 10 \text{mA}, V_{CE} = 10 \text{V} \\ & I_{C} = 150 \text{mA}, V_{CE} = 10 \text{V} \\ & I_{C} = 150 \text{mA}, V_{CE} = 1.0 \text{V} \\ & I_{C} = 500 \text{mA}, V_{CE} = 10 \text{V} \\ \end{split}$	35 50 75 100 50 40	300	
V _{CE(sat)}	Collector-Emitter Saturation Voltage	I _C = 150mA, I _B = 15mA I _C = 500mA, I _B = 50mA		0.3 1.0	V V
V _{BE(sat)}	Base-Emitter Saturation Voltage	I _C = 150mA, I _B = 15mA I _C = 500mA, I _B = 50mA	0.6	1.2 2.0	V V
SMALL SIGN	AL CHARACTERISTICS				1
f _T	Current Gain - Bandwidth Product	I _C = 20mA, V _{CE} = 20V, f = 100mHz	300		MHz
C _{CB}	Collector-Base Capacitance	V _{CB} = 10V, I _E = 0, f = 1.0MHz		8.0	pF
h _{ie}	Input Impedance	$V_{CE} = 10V, I_{C} = 1.0mA,$ f = 1.0kHz	2.0	8.0	kΩ
h _{fe}	Small-Signal Current Gain	$V_{CE} = 10V, I_{C} = 1.0mA,$ f = 1.0kHz	50	300	
h _{oe}	Output Admittance	$V_{CE} = 10V, I_{C} = 1.0mA,$ f = 1.0kHz	5	35	μS
SWITCHING (CHARACTERISTICS			1	ı
t _d	Delay Time	V_{CC} = 30V, $V_{BE(OFF)}$ =		10	ns
t _r	Rise Time	0.5V, I _C = 150mA, I _{B1} = 15mA		25	ns
t _s	Storage Time	$V_{CC} = 30V, I_{C} = 150mA,$		225	ns
t _f	Fall Time	$I_{B1} = I_{B2} = 15mA$		60	ns

Spice Model

NPN (Is=14.34f Xti=3 Eg=1.11 Vaf=74.03 Bf=255.9 Ne=1.307 Ise=14.34f Ikf=.2847 Xtb=1.5 Br=6.092 Nc=2 Isc=0 Ikr=0 Rc=1 Cjc=7.306p Mjc=.3416 Vjc=.75 Fc=.5 Cje=22.01p Mje=.377 Vje=.75 Tr=46.91n Tf=411.1p Itf=.6 Vtf=1.7 Xtf=3 Rb=10)





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